# APPROVAL SHEET

To:

Customer P/N:

UDE P/N: RB1-125BAG1A

Description: RJ45 1X1 Tab Down

Through Hole

10/100Base-T

Contact Area: Gold Flash

LED:L-Green; R-Yellow



Spec No. Update Date RB1111-00 2009/8/27

Approved	Checked	Prepared



# 湧德電子 股份有限公司

11F-1, No.58, Tongde 11th St., Taoyuan City, Taoyuan County (330), Taiwan 桃園縣桃園市(330)同德十一街58號11F之1

TEL:+886-3-3568600 FAX:+886-3-3560611

http://www.ude-corp.com/

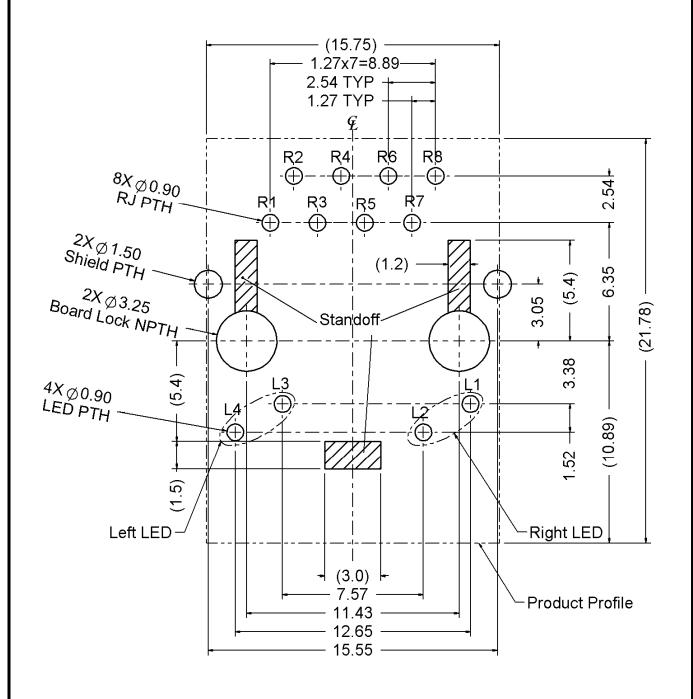
Spec No.: RB1111-00

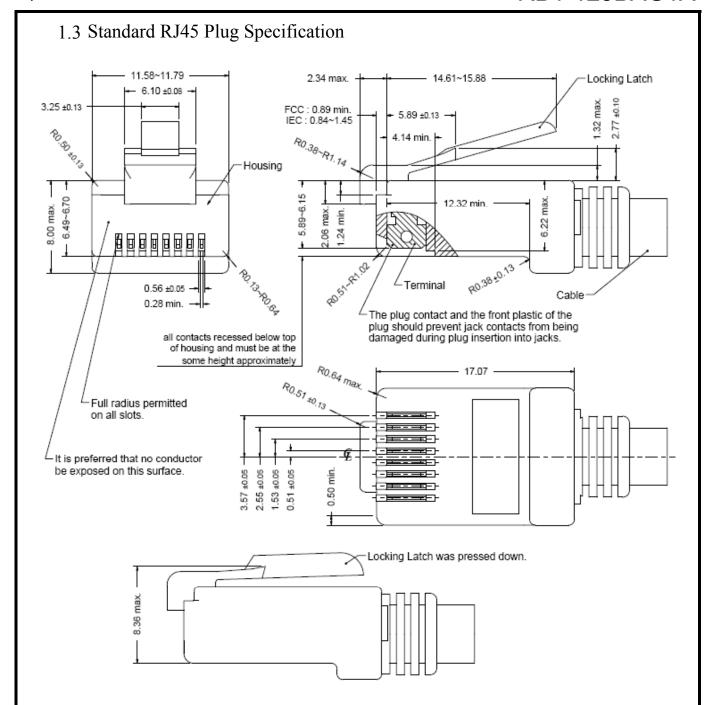
# 1. MECHANICAL DIMENSION 1.1 Product Dimension $X.X : \pm 0.25$ **General Tolerance** X.XX: ± 0.13 X.XXX: ± 0.08 (10.7) -P/N& D/C 2 4 0 (4.0) Back View 15.75 ±0.38 11.80 +0.15 0.00 $1.0 \pm 0.50$ 21.78 ±0.38 8.0 - 6.0 ±0.50 3.4 ±0.50 0.85 ±0.38 0.60 3.2 $0.35 \pm 0.25$ 9.5 Left LED Right LED 0.50LED 0.20 0.35RJ 0.50LED 0.45RJ 1.52 3.05 3.38 11.43 15.55 ±0.38 – 10.89 ±0.25 <del>- |</del> 6.35 <del>- |</del> 12.65 7.57 H(3.0)H Ę Ø3.15 Ø3.15 (5.4)(1.2)1.20 - 1.9 - 3.31 Detail A Detail B 1.27 TYP 2.54 TYP - 1.27x7=8.89 -

# 1.2 Recommened PCB Layout

Component Side of Board

All dimension tolerance are  $\pm 0.05$ mm unless otherwise specified





- All dimensions follow:

FCC subpart F, 68,500, Figure (C)(2)(i) & (C)(2)(ii) & (C)(3)(i) IEC 60603-7

- All plugs must be meeting the requirements of plug Go & No-Go gauge.

  Gauge follow: FCC subpart F, 68,500, Figure (C)(4)(i) & (C)(5)(i)
- There must be no damage to Housing and Locking Latch.
- There must be no nicks and cuts in cable.
- Durability: 750 cycles generally

#### 2. REQUIREMENTS

2.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable.

#### 2.2 Material

2.2.1 Terminal Parts (Underplating : 30µ" min. Nickel overall)

2.2.1.1 RJ Terminal: PH. Bronze, Thickness=0.30mm

Finish: Contact Area: Gold Flash

2.2.1.2 Input Terminal: Brass, Thickness=0.35mm

Finish:  $100\mu$ " min. Tin

2.2.1.3 Case Terminal: Brass, Thickness=0.30mm

Finish: 100µ" min. Tin

2.2.2 Plastic Parts <UL94V-0>

2.2.2.1 Housing: High Temperature Thermoplastic, Black

2.2.2.2 Case: High Temperature Thermoplastic, Black

2.2.3 Shield Parts: Stainless, Thickness=0.20mm, Pre-soldering

Spec No.: RB1111-00

#### 2.3 Operating and Storage Temperature

Operating Temperature : 0°C to +70°C

Storage Temperature : -40°C to +85°C

#### 2.4 RJ45 specifications

Insulation Resistance 500M $\Omega$  min.

Insertion force with the latch depressed 22N max

Removal force with the latch depressed 44N max

Locking Force of Plug Latch: 50N min. @ 60+/-5 sec

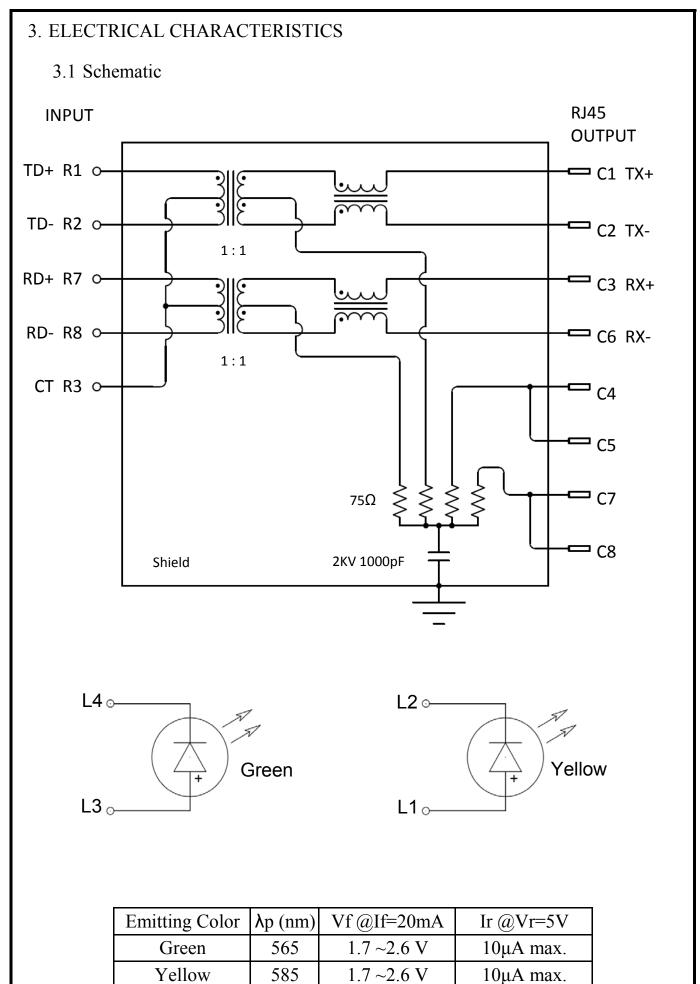
Durability: 2500 cycles

# 2.5 Performance and Test Description

Product is designed to meet electrical, mechanical and environmental performance requirements specified in below table. All tests are performed at ambient environmental conditions per MIL-STD-1344A and EIA-364 unless otherwise specified.

# 2.6 Packaging and Packing

All parts shall be packaged and packed to protect against physical damage \cdot corrosion and deterioration during shipment and storage.



Spec No.: RB1111-00

3.2 Transmitter filter & Receiver filter

Type: Balance low pass  $100\Omega$  impedance

Insertion loss: 1~100 MHz -1.0dB max.

Return loss:  $1\sim30 \text{ MHz}$  -18dB min. load  $100\Omega$ 

 $30\sim60 \text{MHz}$  -16dB min. load  $100\Omega$ 

 $60\sim80\text{MHz}$  -12dB min. load  $100\Omega$ 

- 3.3 Common Mode Rejection
  - @ 1~100 MHz -30dB min.
- 3.4 Cross Talk
  - @ 1~100 MHz -30dB min.
- 3.5 Inductance @ 100KHz, 0.1V, 8mA DC BIAS

Input(R1-R2), Input(R7-R8) : 350 μH min.

3.6 HiPot Test

Input(R1-R2) To Output(C1-C2): 1500Vac 60s or 2250Vdc 60s

Input(R7-R8) To Output(C3-C6): 1500Vac 60s or 2250Vdc 60s

# 4. ORDER INFORMATION

## A. LED Code:

L-Green; R-Yellow. < Refer to Schematic of LED>

# B. Mechanical Code:

w/ UDE Logo, w/ all Spring, Rear side Leg, Board Lock

# C. Schematics Code:

AG1: AG1 circuit

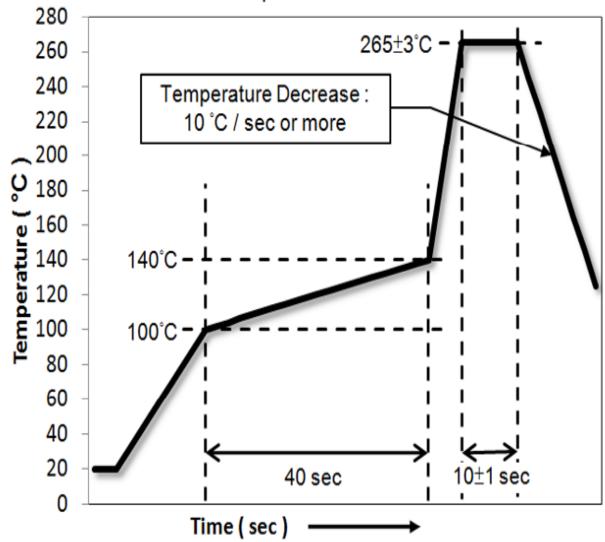
# D. Plating Code:

Underplating	$30 \mu$ " min. Nickel overall		
Solder Tail	$100\mu$ " min. Bright Tin	$100\mu$ " min. Matted Tin	
Contact Area	A: Gold Flash	1 : Gold Flash	
	C : 6 μ " gold	6 : 6 μ " gold	
	B : 10 μ " gold		
	D : 15 μ " gold	2 : 15 μ " gold	
	F : 30 μ " gold	$3:30\mu$ " gold	
	G : 50 μ " gold	4 : 50 μ " gold	

# 5. DIPPING TEMPERATURE PROFILE

# Note:

The measuring point for the specified temperature shall be on the soldered part of the lead.



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

WIZnet:

RB1-125BAG1A